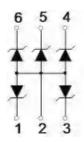


Discription

The HCEST363NC5VU is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail. A zener diode is integrated in to the array between the positive and negative supply rails. In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.

5 4

SOT-363



Circuit Diagram

Features

- ★ Uni-directional ESD protection of 5 lines
- ★ IEC 61000-4-2 Level 4 ESD protection
- ★ Low reverse stand-off voltage: 5V
- ★ Low reverse clamping voltage
- ★ Low leakage current
- ★ Fast response time
- ★ Small package saves board space
- ★ RoHS compliant

Orderingin formation

Product ID	Pack	Qty(PCS)
HCEST363NC5VU	SOT-363	3000

Absolute Ratings(Tamb = 25°C)

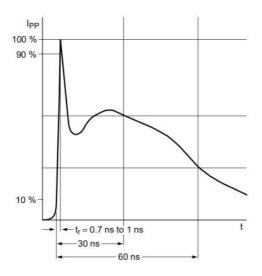
Parameter	Symbol	Value	Unit
Peak Pulse Power(Tp=8/20µs)	P _{PPM}	60	W
Rated PeakPulse Current(Tp=8/20µs)	І РРМ	5	Α
ESD voltage IEC61000-4-2(airdischarge)	VESD	20	kV
ESD voltage IEC61000-4-2(contactdischarge)	Vesd	15	kV
Maximum lead temperature for soldering during 10s	TL	260	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Operating Temperature Range	Тор	-40 to +125	°C



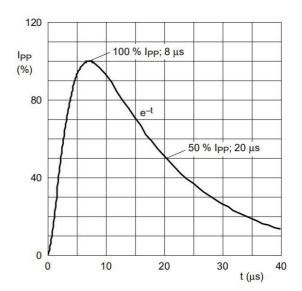
Electrical Characteristics (Tamb=25°C)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Reverse Working Voltage	V _{RWM}			5.0	V	
Breakdown Voltage	V _{BR}	6.0		7.5	V	I⊤=1mA
Leakage Currentl Leak	I _R			100	nA	V _{RWM} =5V
Clamping Voltage	Vc			9.0	V	IPP=1A,Tp=8/20µs
Clamping Voltage	Vc			12.0	V	IPP=5A,Tp=8/20µs
Junction Capacitance	C _j		30	35	pF	V _R =0V,f=1MHz

Typical Characteristics



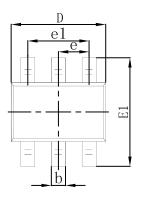
IEC61000-4-2 Waveform

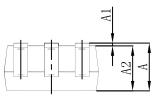


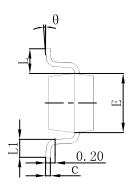
IEC 61000-4-5 Waveform(8/20µs pulse)



SOT-363 Package Outline Dimensions

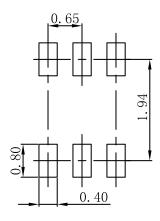






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
р	0.150	0.350	0.006	0.014	
С	0.100	0.150	0.004	0.006	
D	2.000	2.200	0.079	0.087	
Е	1.150	1.350	0.045	0.053	
E1	2.150	2.400	0.085	0.094	
е	0.650 TYP		0.026 TYP		
e1	1.200	1.400	0.047	0.055	
L	0.525 REF		0.021 REF		
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

SOT-363 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

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